

REMARKS

The Office Action dated April 21, 2004 has been reviewed and carefully considered. Reconsideration of the above-identified application in view of the following remarks is respectfully requested.

Claims 1-20 stand provisionally rejected under the judicially created doctrine of double patenting over claims 1-16 of copending Application No. 10/210,240.

The analysis in item 4 of the Office Action, although apparently indicative of Application No. 10/210,240, i.e., U.S. Patent Publication 20040023058, is unfortunately not indicative of the present, pending U.S. Patent Application serial number 10/721,712.

The latter document is entitled as shown above in the letterhead, and clearly does not relate to the former document, entitled "Dielectric interconnect frame incorporating EMI shield and hydrogen absorber for tile T/R modules."

In particular, and by way of non-limitative and illustrative example, the current patent application, serial number 10/721,712, is assigned to Samsung, whereas the cited application, serial number 10/210,240 is a Raytheon application. Nor is any inventor of one application an inventor on the other application.

As a further example, the present applicants note, with specific reference to the second sentence in item 4 of the Office Action and contrary to what is said in that sentence, that the claims of the present application do not require any one or combination of an oxidation preventing layer, an electrically conductive layer and a synthetic resin dielectric.

For at least all of the above reasons, the double patenting rejection is invalid.

Reconsideration and withdrawal of the rejection is respectfully requested.

In view of the foregoing amendments and remarks, Applicants respectfully request favorable reconsideration and early passage to issue of the present application.

If any issues remain which might best be resolved through a telephone communication, the Examiner is requested to kindly telephone the undersigned telephone number listed below. If there are any fees and owing, please charge Deposit Account No. 502-470.

Respectfully submitted,

CHA & REITER

By:


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Date:

6/11/04

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to the COMMISSIONER FOR PATENTS, ALEXANDRIA, VA 22313 on 6/11/04.


(Steve Cha, Reg. No. 44,069)


(Signature and Date)